Si3457DV

Single P-Channel Logic Level PowerTrench[®] MOSFET

General Description

FAIRCHILD

This P-Channel Logic Level MOSFET is produced using Fairchild's advanced PowerTrench process. It has been optimized for battery power management applications.

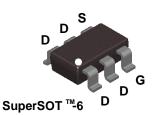
Applications

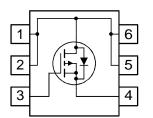
- Battery management
- · Load switch
- Battery protection

Features

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- Low gate charge
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$





Absolute Maximum Ratings T_{A=25°C} unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-30	V
V _{GSS}	Gate-Source Voltage		±25	V
ID	Drain Current – Continuous	(Note 1a)	-4	A
	- Pulsed		-20	
P _D	Maximum Power Dissipation	(Note 1a)	1.6	W
		(Note 1b)	0.8	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

R_{6JA} Thermal Resistance, Junction-to-Ambient (Note 1a) 78 °C/W R_{6JC} Thermal Resistance, Junction-to-Case (Note 1) 30 °C/W

Package Marking and Ordering Information

.457 Si3457DV 7" 8mm	vice Marking Device	Reel Size Tape width Qua	ntity
	.457 Si3457DV	7" 8mm 3000	units

Si3457DV

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_D = -250 \mu A$	-30			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$		-22		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = -24 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			-1	μA
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 25 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
I _{GSSR}	Gate–Body Leakage, Reverse	$V_{GS} = -25 \text{ V} \qquad V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)	•				
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-1	-1.8	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$		4		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{ccc} V_{GS} = -10 \ V, & I_D = -4 \ A \\ V_{GS} = -4.5 \ V, & I_D = -3.4 \ A \\ V_{GS} = -10 \ V, \ I_D = -4 \ A; T_J = 125^{\circ} \end{array} $		44 67 60	50 75 70	mΩ
I _{D(on)}	On–State Drain Current	$V_{GS} = -10 \text{ V}, \qquad V_{DS} = -5 \text{ V}$	-20			Α
g fs	Forward Transconductance	$V_{\text{DS}} = -5 \text{ V}, \qquad I_{\text{D}} = -4 \text{ A}$		8.4		S
Dynamic	c Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = -15 V$, $V_{GS} = 0 V$, f = 1.0 MHz		470		pF
Coss	Output Capacitance			126		pF
C _{rss}	Reverse Transfer Capacitance			61		pF
Switchir	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -15 V$, $I_D = -1 A$,		7	14	ns
t _r	Turn–On Rise Time	$V_{GS} = -10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		12	22	ns
t _{d(off)}	Turn–Off Delay Time	7		16	29	ns
t _f	Turn–Off Fall Time			6	12	ns
Qg	Total Gate Charge	$V_{DS} = -15 V$, $I_{D} = -4 A$,		6	8.1	nC
Q _{gs}	Gate-Source Charge	$V_{GS} =5 V$		2.1		nC
Q _{gd}	Gate-Drain Charge			2		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain–Source Diode Forward Current				-1.3	А
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = -1.3 A$ (Note 2)		-0.77	-1.2	V

1. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a) 78°C/W when mounted on a 1in² pad of 2 oz copper

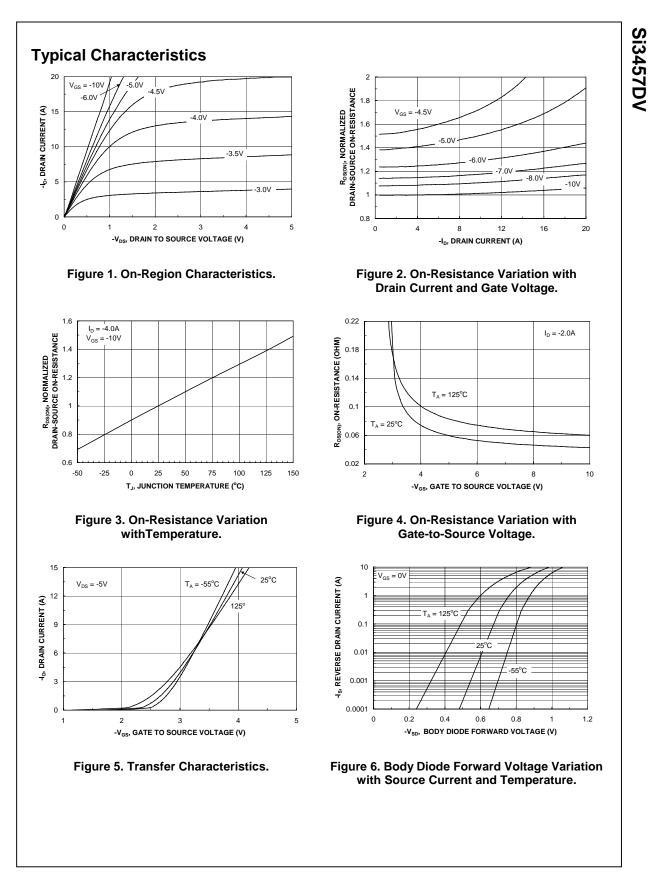


b) 156°C/W when mounted on a minimum pad of 2 oz copper

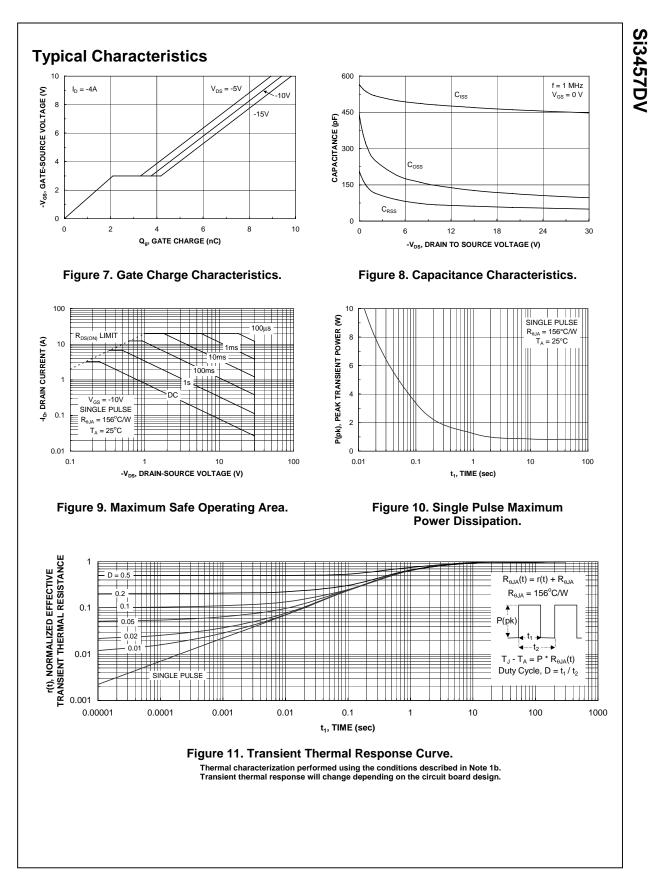
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

Si3457DV Rev A(W)



Si3457DV Rev A(W)



Si3457DV Rev A(W)

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